BL9161

300mA Ultra-low Noise, Ultra-Fast CMOS LDO Regulator

FEATURES

- Ultra-low Noise
- Ultra-Fast Response in Line/Load Transient
- 0.01μA Standby Current When Shutdown
- Low Dropout: 230mV@300mA
- Wide Operating Voltage Ranges: 2.2V to 5.5V
- Low Temperature Coefficient
- Current Limiting Protection
- Thermal Shutdown Protection
- Only 1μF Output Capacitor Required for Stability
- High Power Supply Rejection Ratio
- Fast output discharge
- Available in SOT23-5，SOT23-3, SC70-5 and DFN1×1-4L Package

APPLICATIONS

- Cellular and Smart Phones
- Cordless Telephones
- Battery-Powered Equipment
- Laptop, Palmtops, Notebook Computers
- Hand-Held Instruments
- PCMCIA Cards
- MP3/MP4/MP5 Players
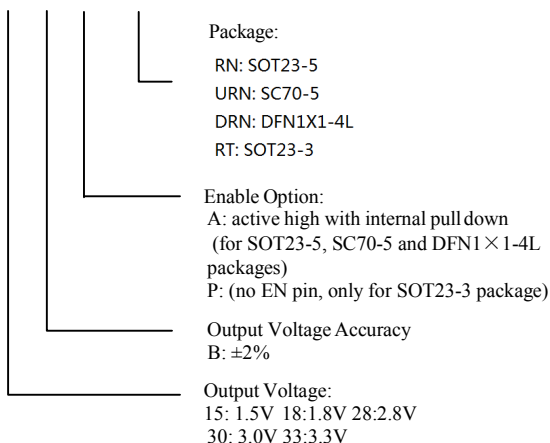- Portable Information Appliances

DESCRIPTION

The BL9161 is designed for portable applications with demanding performance and space requirements. The BL9161 performance is optimized for battery-powered systems to deliver ultra low noise and low quiescent current. Regulator ground current increases only slightly in dropout, further prolonging the battery life. The BL9161 also works with low-ESR ceramic capacitors, reducing the amount of board space necessary for power applications, critical in hand-held wireless devices. The BL9161 consumes only 0.01μA current in shutdown mode and has fast turn-on time (Typical 50μs). The other features include ultra low dropout voltage, high output accuracy, current limiting protection, and high ripple rejection ratio.

ORDERING INFORMATION
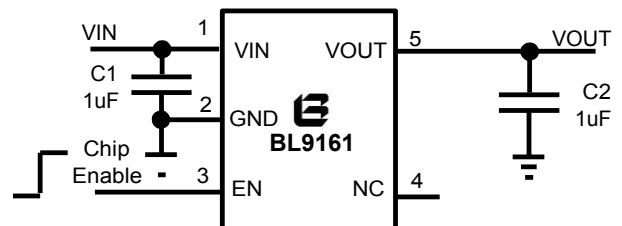
BL9161 XX X X XXX

Package:
RN: SOT23-5
URN: SC70-5
DRN: DFN1X1-4L
RT: SOT23-3

Enable Option:
A: active high with internal pull down
(for SOT23-5, SC70-5 and DFN1×1-4L packages)
P: (no EN pin, only for SOT23-3 package)

Output Voltage Accuracy
B: ±2%

Output Voltage:
15: 1.5V 18:1.8V 28:2.8V
30: 3.0V 33:3.3V

TYPICAL APPLICATION

Application hints:

Output capacitor (C2≥ 2.2uF) is recommended in BL9161-1.5V and BL9161-1.8V application to assure the stability of circuit.

Absolute Maximum Rating (Note 1)

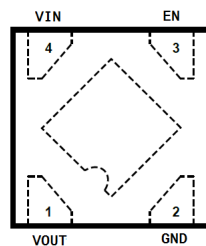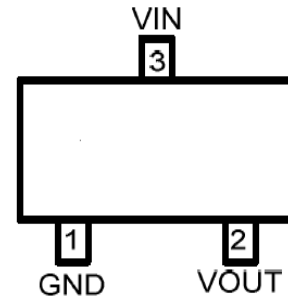|			
Input Supply Voltage (VIN)	-0.3V to +6V	Maximum Junction Temperature	150°C
EN Pin Input Voltage	-0.3V to VIN	Operating Temperature Range (Note2)	-40°C to 85°C
Output Voltages	-0.3V to VIN+0.3V	Storage Temperature Range	-65°C to 125°C
Output Current	300mA	Lead Temperature (Soldering, 10s)	300°C

PIN CONFIGURATIONS

SOT23-5 &SC70-5(TOP VIEW)
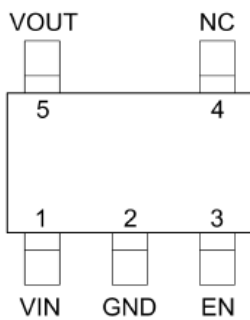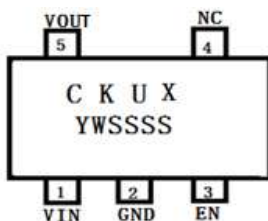

DFN1X1-4L(TOP VIEW)

SOT23-3(TOP VIEW)

Package Marking

SOT23-5 ,SOT23-3 &SC70-5

DFN1×1-4L

CKU: Chip ID
X: Output voltage
Y: Data code--Year
W: Data code—Week

Thermal Resistance (Note3):

Package	Θ_{JA}	Θ_{JC}
SOT23-5	250℃/W	130℃/W
SC70-5	333℃/W	170℃/W

Output voltage	1.5V	1.8V	2.8V	3.0V	3.3V
X(SOT23-5, SOT23-3& SC70-5)	C	D	G	I	K
X(DFN1×1-4L)	E	D	C	B	A

Y	4	5	6	…	0	1	…
Year	2014	2015	2016	…	2020	2021	…

W	A	…	Y	Z	a	…	y	z
Week	1	…	25	26	27	…	51	52

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.
Note 2: The BL9161 is guaranteed to meet performance specifications from 0°C to 70°C. Specifications over the −40°C to 85°C operating temperature range are assured by design, characterization and correlation withstatistical process controls.
Note 3: Thermal Resistance is specified with approximately 1 square of 1 ozcopper.

Pin Description

### SOT23-5 , SC70-5 & SOT23-3

PIN		NAME	FUNCTION
SOT23-5 &SC70-5	SOT23-3		
1	3	VIN	Power Input Voltage.
2	1	GND	Ground.
3		EN	Chip Enable Pin, This pin has an internal pull-down resistor
4		NC	No Connection.
5	2	VOUT	Output Voltage.

DFN1X1-4L

PIN	NAME	FUNCTION
1	VOUT	Output Voltage.
2	GND	Ground.
3	EN	Chip Enable Pin, This pin has an internal pull-down resistor
4	VIN	Power Input Voltage.
Exposed Pad		The exposed pad should be connected to a large ground plane to maximize thermal performance.

Block Diagram
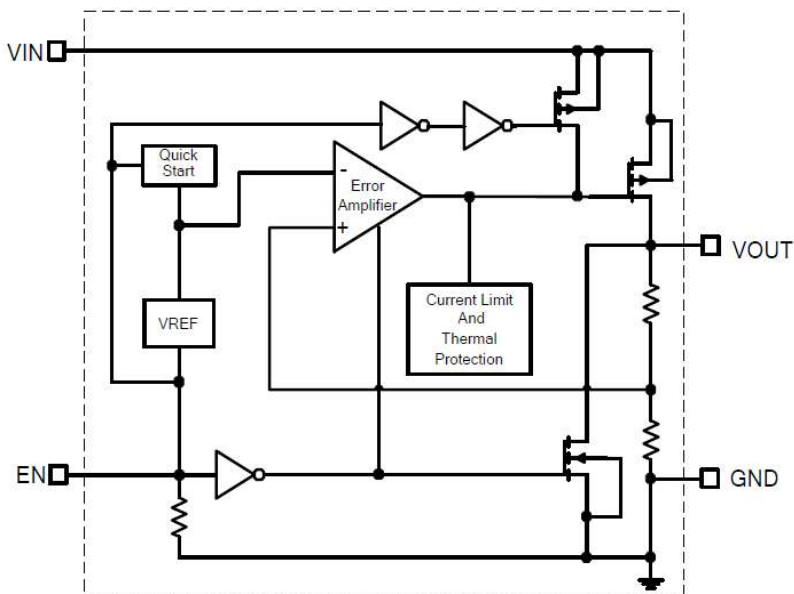
Electrical Characteristics [(Note 4)]

(V_{IN}=Vout +1V, EN=V_{IN}, C_{IN}=C_{OUT}=1μF, T_A=25℃, unless otherwise noted.)

Parameter		Symbol	Conditions	MIN	TYP	MAX	unit
Input Voltage		V_{IN}		2.2		5.5	V
Output Voltage Accuracy		ΔV_{OUT}	V_{IN}=Vout+1V, I_{OUT}=1mA	-2		+2	%
Current Limit		I_{LIM}	R_{LOAD}=1Ω	360	450		mA
Quiescent Current		I_Q	V_{EN}>1.2V, I_{OUT}=0mA		70	110	μA
Dropout Voltage		V_{DROP}	I_{OUT}=200mA, V_{OUT}=3.3V		150	200	mV
			I_{OUT}=300mA, V_{OUT}=3.3V		230	300	
Line Regulation[(Note 5)]		ΔV_{LINE}	V_{IN}=Vout+1V to 5.5V I_{OUT}=1mA		0.02	0.17	%/V
Load Regulation[(Note6)]		ΔV_{LOAD}	1mA<I_{OUT}<300mA		20		mV
Output Voltage[(Note 7)] Temperature Coefficient		TC_{VOUT}	I_{OUT}=1mA		±60		ppm/℃
Standby Current		I_{STBY}	V_{EN}=GND, Shutdown		0.01	1	μA
EN Input Bias Current		I_{IBSD}	V_{EN}=GND or V_{IN}			2	μA
EN Input Threshold	Logic Low	V_{IL}	V_{IN}=3V to 5.5V, Shutdown			0.4	V
	Logic High	V_{IH}	V_{IN}=3V to 5.5V, Start up	1.2			V
Output Noise Voltage		e_{NO}	10Hz to100KHz, I_{OUT}=100mA		150		μV_{RMS}
Power Supply Rejection Ratio	f=217Hz	PSRR	I_{OUT}=10mA		-78		dB
	f=1KHz				-71		
	f=10KHz				-53		
Thermal Shutdown Temperature		T_{SD}	Shutdown, Temp increasing		170		℃
Thermal Shutdown Hysteresis		T_{SDHY}			30		℃

Note 4: Production test at +25°C. Specifications over the temperature range are guaranteed by design and characterization.

Note 5: Line regulation is calculated by $\Delta V_{LINE} = \left| \frac{V_{OUT1} - V_{OUT2}}{\Delta V_{IN} \times V_{OUT(normal)}} \right| \times 100$

Where V_{OUT1} is the output voltage when V_{IN}=5.5V, and V_{OUT2} is the output voltage when V_{IN}=4.3V,

ΔV_{IN}=1.2V. V_{OUT} (normal) =3.3V.
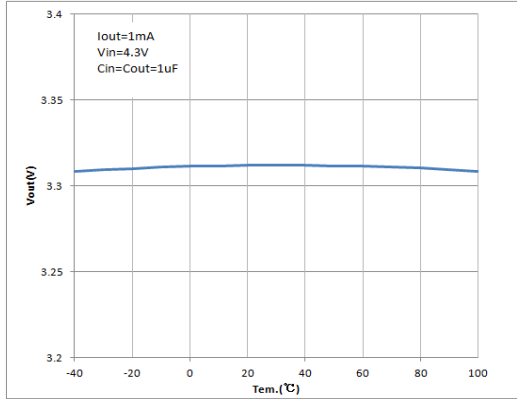
Note 6: Load regulation is calculated by V_{load}=Vout1-Vout2
Where V_{OUT1} is the output voltage when I_{OUT}=1mA, and V_{OUT2} is the output voltage when I_{OUT}=300mA.
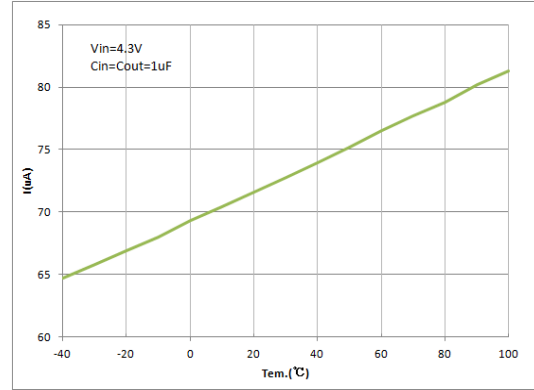
Note 7: The temperature coefficient is calculated by $TC_{V_{OUT}} = \frac{\Delta V_{OUT}}{\Delta T \times V_{OUT}}$
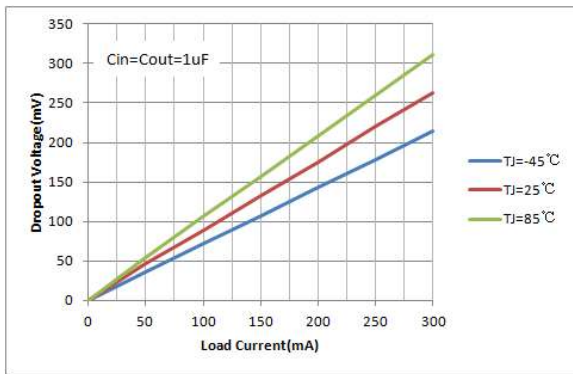
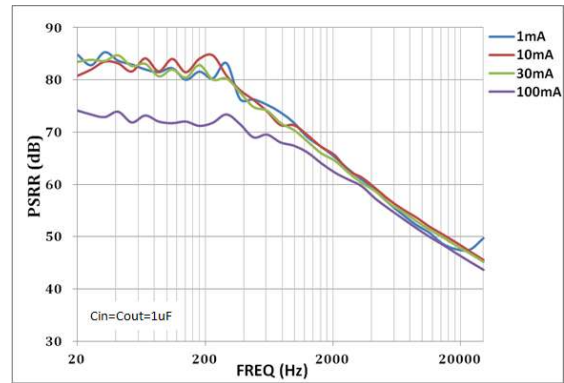## Typical Performance Characteristics

Output Voltage Vs. Temperature
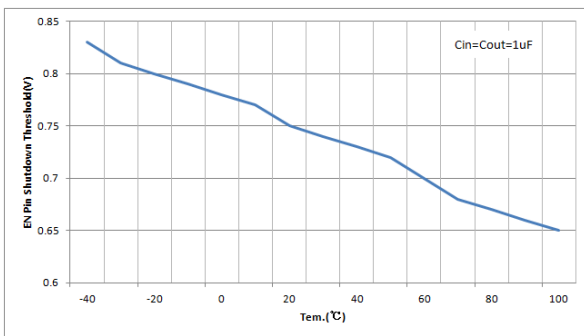

Quiescent Current Vs. Temperature
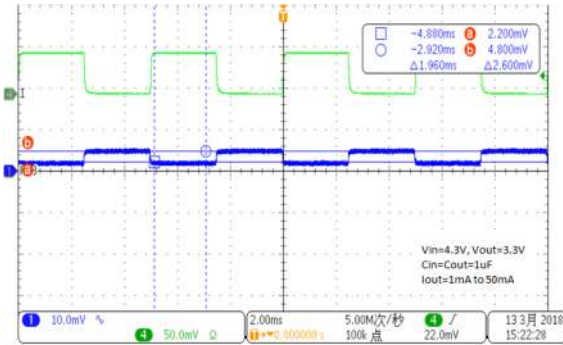

Dropout Voltage Vs. Load Current

PSRR

EN Pin Shutdown Threshold Vs. Temperature

Load Transient Response

Vin=4.3V, Vout=3.3V
Cin=Cout=1uF
Iout=1mA to 50mA

Load Transient Response

Vin=4.3V, Vout=3.3V
Cin=Cout=1uF
Iout=1mA to 250mA

Line transient Response

Vin=4.3V, Vout=3.3V
Cin=Cout=1uF
Iout=1mA

Start up

Vin=4.3V, Vout=3.3V
Cin=Cout=1uF
No load
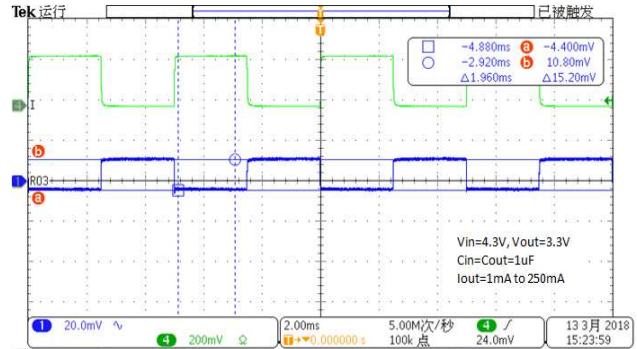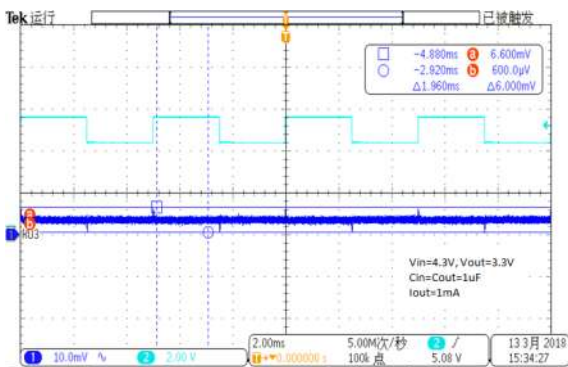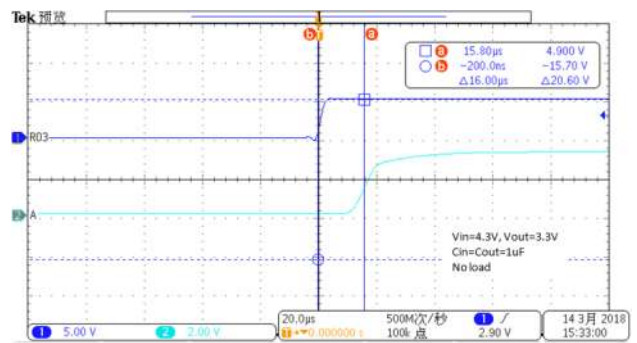
EN Pin Shutdown Response

Vin=4.3V, Vout=3.3V
Cin=Cout=1uF
No load
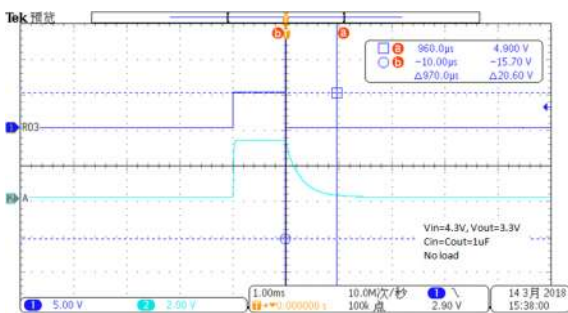
Applications Information

Like any low-dropout regulator, the external capacitors used with the BL9161 must be carefully selected for regulator stability and performance. Using a capacitor whose value is > 1μF on the BL9161 input and the amount of capacitance can be increased without limit. The input capacitor must be located a distance of not more than 0.5 inch from the input pin of the IC and returned to a clean analog ground. Any good quality ceramic or tantalum can be used for this capacitor. The capacitor with larger value and lower ESR (equivalent series resistance) provides better PSRR and line-transient response. The output capacitor must meet both requirements for minimum amount of capacitance and ESR in all LDOs application. The BL9161 is designed specifically to work with low ESR ceramic output capacitor in space-saving and performance consideration. Using a ceramic capacitor whose value is at least 1μF with ESR is > 25mΩ on the BL9161 output ensures stability. The BL9161 still works well with output capacitor of other types due to the wide stable ESR range. Output capacitor of larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located not more than 0.5 inch from the V_{OUT} pin of the BL9161 and returned to a clean analog ground.

Enable Function

The BL9161 features an LDO regulator enable/disable function. To assure the LDO regulator will switch on; the EN turn on control level must be greater than 1.2 volts. The LDO regulator will go into the shutdown mode when the voltage on the EN pin falls below 0.4 volts. For to protect the system, the BL9161 have a quick discharge function. If the enable function is not needed in a specific application, it may be tied to V_{IN} to keep the LDO regulator in a continuously on state.

Thermal Considerations

Thermal protection limits power dissipation in BL9161. When the operation junction temperature exceeds 170°C, the OTP circuit starts the thermal shutdown function turn the pass element off. The pass element turns on again after the junction temperature cools by 30°C.

For continue operation, do not exceed absolute maximum operation junction temperature 125°C. The power dissipation definition in device is:

$$P_D(MAX) = (T_J(MAX) - T_A)/\theta_{JA}$$

Where $T_J(MAX)$ is the maximum operation junction temperature 125°C, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance. For recommended operating conditions specification of BL9161, where $T_J(MAX)$ is the maximum junction temperature of the die (125°C) and T_A is the maximum ambient temperature. The junction to ambient thermal resistance (θ_{JA} is layout dependent) for SOT-23-5 package is 250°C/W, on standard JEDEC 51-3 thermal test board. The maximum power dissipation at T_A= 25°C can be calculated by following formula:

$P_D(MAX) = (125°C-25°C)/250 = 400mW$ (SOT-23-5)

The maximum power dissipation depends on operating ambient temperature for fixed $T_J(MAX)$ and thermal resistance θ_{JA}. It is also useful to calculate the junction of temperature of the BL9161 under a set of specific conditions. In this example let the Input voltage V_{IN}=3.3V, the output current Io=300mA and the case temperature T_A=40°C measured by a thermal couple during operation. The power dissipation for the V_{OUT}=2.8V version of the BL9161 can be calculated as:

$P_D = (3.3V-2.8V)×300mA+3.6V×100uA$
$=150mW$

And the junction temperature, T_J, can be calculated as follows:

$T_J=T_A+P_D×\theta_{JA}=40°C+0.15W×250°C/W$
$=40°C+37.5°C=77.5°C<T_J(MAX)=125°C$

For this operating condition, T_J is lower than the absolute maximum operating junction temperature,125°C, so it is safe to use the BL9161 in this configuration.
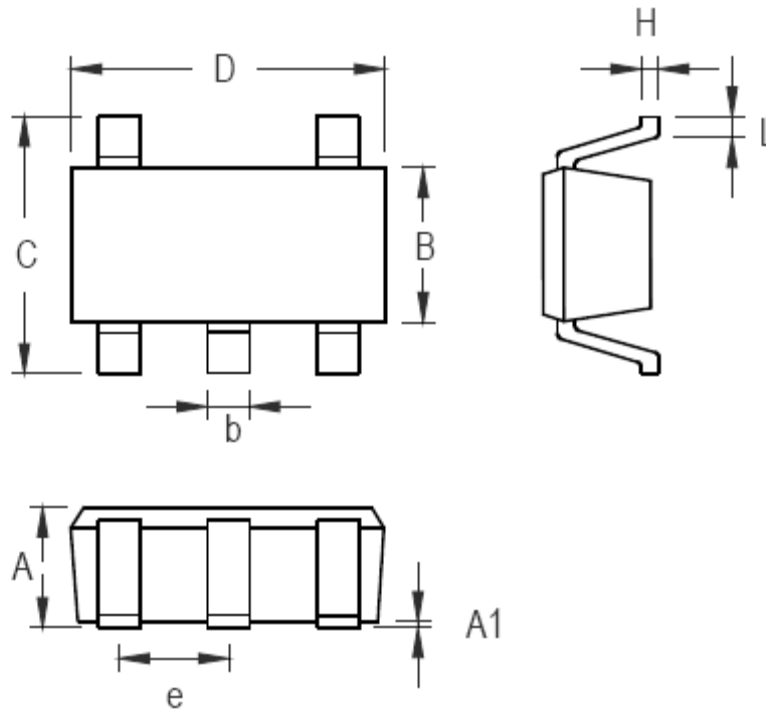
Layout considerations

To improve ac performance such as PSRR, output noise, and transient response, it is recommended that the PCB be designed with separate ground planes for V_{IN} and V_{OUT}, with each ground plane connected only at the GND pin of the device.
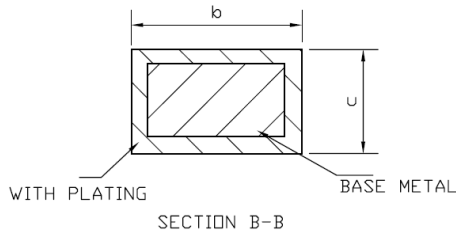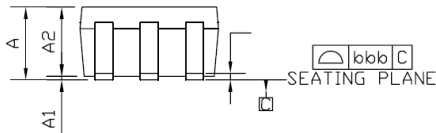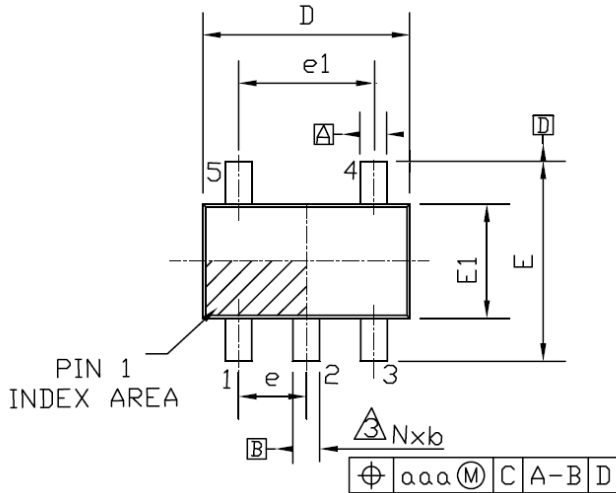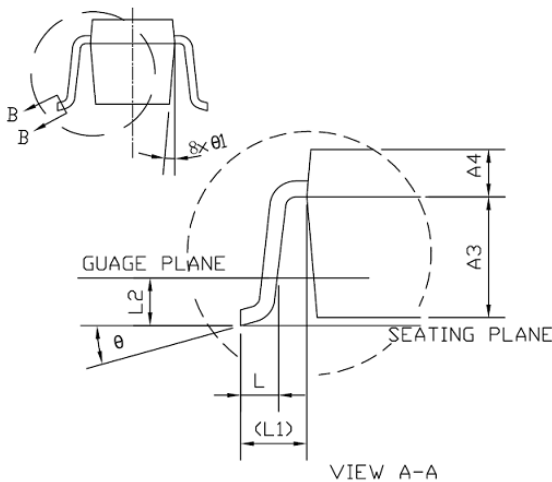
Package Description

SOT23-5

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	**Max**	**Min**	**Max**
A	0.889	1.295	0.035	0.051
A1	0.000	0.152	0.000	0.006
B	1.397	1.803	0.055	0.071
b	0.356	0.559	0.014	0.022
C	2.591	2.997	0.102	0.118
D	2.692	3.099	0.106	0.122
e	0.838	1.041	0.033	0.041
H	0.080	0.254	0.003	0.010
L	0.300	0.610	0.012	0.024

SC70-5

COMMON DIMENSION			
SYMBOL	IN MILLIMETERS		
	MIN	NOMAL	MAX
A	0.80	–	1.10
A1	0	–	0.10
A2	0.80	0.90	1.00
A3	0.47	0.52	0.57
A4	0.33	0.38	0.43
b	0.15	–	0.30
c	0.10	–	0.25
D	1.85	2.00	2.20
e	0.65 BSC		
e1	1.30 BSC		
E	1.80	2.10	2.40
E1	1.15	1.25	1.35
L	0.10	–	0.45
L1	0.42 REF.		
L2	0.20 BSC		
θ	0°	4°	30°
θ1	4°	–	12°
aaa	0.10		
bbb	0.10		

DFN1×1-4L

1.000±0.050

1.000±0.050

4L STSLP
(1×1mm)

PIN 1# DOT
BY MARKING

TOP VIEW

0.500±0.050
Exp.DAP

0.625
Bsc

0.500±0.050
Exp.DAP

0.250±0.050

0.225±0.050

4-C0.18

PIN #1 IDENTIFICATION
CHAMFER R0.075mm
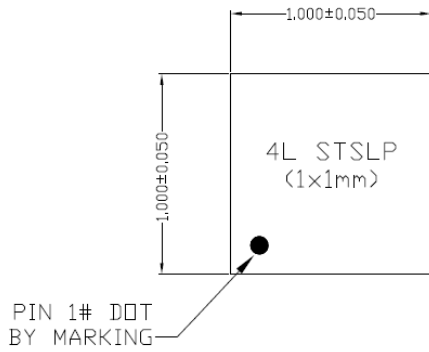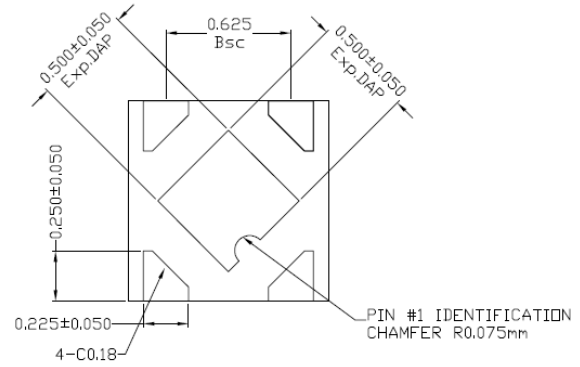
BOTTOM VIEW

NOTE:

1). 'A' DIMENSION AS BELOW TABLE

		STSLP
A	MAX.	0.600
	NOM.	0.550
	MIN.	0.500

A

0.000-0.050

0.152 Ref.

SIDE VIEW

SOT23-3